

HCS05FF120E0R1

1200V/5.5mΩ Half Bridge SiC MOSFET Module

Description

The HCS05FF120E0R1 is a half bridge SiC MOSFET Power Module. It integrates high performance SiC MOSFET chips designed for the applications such as Solar Inverter Systems, Fuelcell-DC/DC converter, Uninterruptible Power Supplier, Energy Storage Systems.



Features

- Blocking voltage:1200V
- 5.5mΩ Rds(on)
- Low Switching Losses
- 175°C maximum junction temperature
- Si3N4 AMB
- Thermistor inside

Applications

- Solar inverter Systems
- Fuel cell-DC/DC converter
- Uninterruptible Power Supplier
- Energy Storage Systems

Circuit diagram

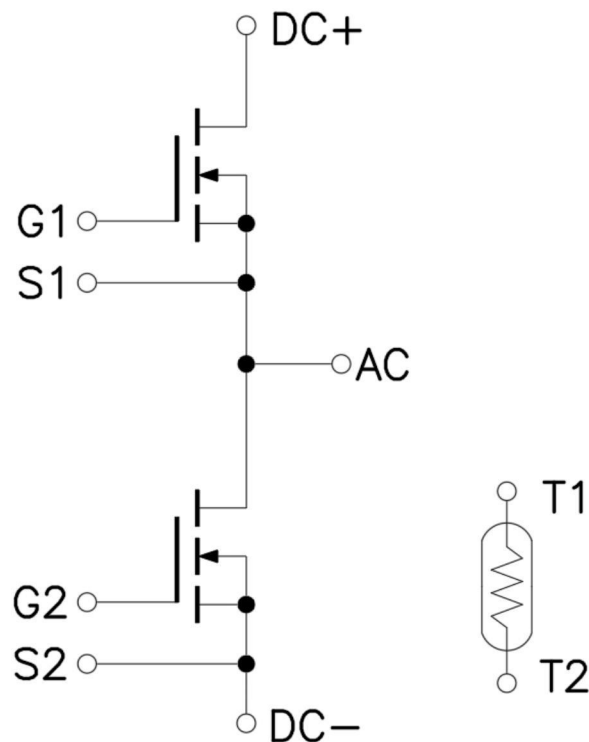


Figure 1. Out drawing & circuit diagram for HCS05FF120E0R1

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Pin Configuration and Marking Information

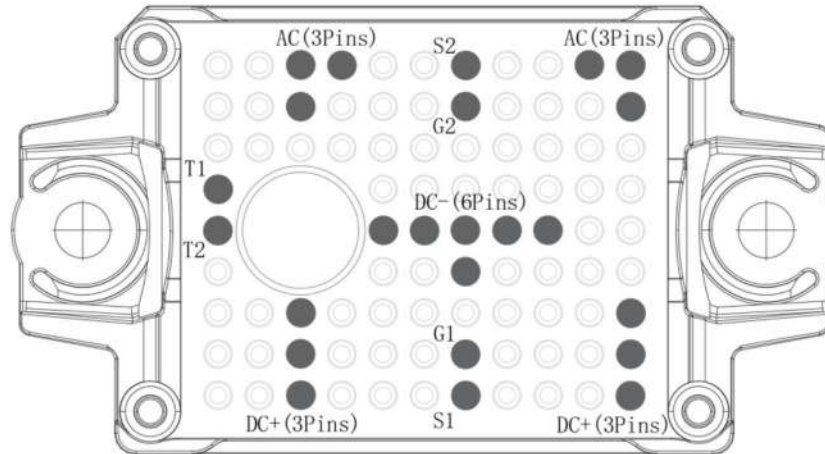


Figure 2. Pin configuration

Symbol	Description
AC	Output terminal of half bridge
S2	Low side source signal terminal
G2	Low side gate signal terminal
DC+	DC+ Bus connection
DC-	DC- Bus connection
S1	High side source signal terminal
G1	High side gate signal terminal
T1	Thermistor connection 1
T2	Thermistor connection 2

Module

Parameter	Conditions	Value	Unit
Isolation voltage	RMS, f=50Hz, t =1min	3.4	kV
Clearance	Terminal to Terminal	5	mm
	Terminal to Heatsink	10	mm
Creepage distance	Terminal to Terminal	6.3	mm
	Terminal to Heatsink	12.7	mm
Comparative Tracking Index	-	600	-
Weight	-	26	g

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Maximum Ratings ($T_j=25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
V_{DSS}	Drain-Source Voltage	G-S Short	1200	V
V_{GSS}	Gate-Source Voltage(+)	D-S Short	21	V
V_{GSS}	Gate-Source Voltage(-)	D-S Short	-2	V
$V_{GSSurge}$	G-S Voltage($t_{surge}<300\text{nsec}$)	D-S Short, Note1	-6 to 23	V
I_{DS}	DC Continuous Drain Current	$T_r=95^{\circ}\text{C}$, Note2	150	A
I_{SD}	Source (Body diode) Current	$T_r=95^{\circ}\text{C}$, with ON signal	150	A
I_{DP}	Drain Pulse Current, Peak	Less than 1ms, Note3	400	A
T_j	junction temperature	-	-40 to 175	$^{\circ}\text{C}$
T_{stg}	Storage temperature	-	-40 to 125	$^{\circ}\text{C}$

Note1: Recommended Operating Value, +18V/0V.

Note2: Case temperature(T_c) is defined on the surface of base plate just under the chips.

Note3: Pulse width limited by maximum junction temperature

NTC characteristics

Symbol	Parameter	Condition	Value			Unit
			Min.	Typ.	Max.	
R_{25}	Resistance	$T_c=25^{\circ}\text{C}$	-	5	-	kΩ
$\Delta R/R$	Deviation of R_{100}	$T_c=100^{\circ}\text{C}$, $R_{100}=493\Omega$	5	-	5	%
P_{25}	Power dissipation	$T_c=25^{\circ}\text{C}$	-	-	20	mW
$B_{25/50}$	B-value	$R_2=R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$	-	3375	-	K
$B_{25/80}$	B-value	$R_2=R_{25} \exp [B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$	-	3411	-	K
$B_{25/100}$	B-value	$R_2=R_{25} \exp [B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$	-	3433	-	K

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1200V/5.5mΩ Half Bridge SiC MOSFET Module

MOSFET Electrical characteristics ($T_j=25^\circ\text{C}$ unless otherwise specified, chip)

Symbol	Item	Condition	Value			Unit	
			Min.	Typ.	Max		
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=1mA$	1200	-	-	V	
I_{DSS}	Zero gate voltage drain current	$V_{DS}=1200V, V_{GS}=0V$	-	-	160	μA	
$V_{GS(th)}$	Gate-source threshold voltage	$I_D=73mA, V_{DS}=V_{GS}$	2.8	-	4.8	V	
I_{GSS+}	Gate-Source Leakage Current	$V_{GS}=21V, V_{DS}=0V, T_j=25^\circ C$	-	-	200	nA	
I_{GSS-}		$V_{GS}=-2V, V_{DS}=0V, T_j=25^\circ C$	-200	-	-	nA	
$R_{DS(on)}$ (Chip)	Static drain-source On-state resistance	$I_D=150A$ $V_{GS}=+18V$	$T_j=25^\circ C$	-	5.5	6.9	mΩ
			$T_j=175^\circ C$	-	13	-	mΩ
$V_{DS(on)}$ (Chip)	Static drain-source On-state voltage	$I_D=150A$ $V_{GS}=+18V$	$T_j=25^\circ C$	-	0.83	1.04	V
			$T_j=175^\circ C$	-	1.95	-	V
C_{iss}	Input capacitance	$V_D=10V, V_{GS}=0V, f=200kHz$	-	14.5	-	nF	
C_{oss}	Output capacitance		-	0.4	-	nF	
C_{rss}	Reverse transfer capacitance		-	0.03	-	nF	
Q_G	Total gate charge	$V_{DD}=600V, I_D=150A, V_{GS}=+15/0V$	-	520	-	nC	
R_{Gint}	Internal Gate Resistance	$T_j=25^\circ C$	-	1.9	-	Ω	
$t_{d(on)}$	Turn-on delay time	$V_{DD}=600V$ $I_D=150A$ $V_{GS}=+18/0V$ $R_G=3.3\Omega$ Inductive load switching operation	$T_j=25^\circ C$	-	58	-	ns
			$T_j=150^\circ C$	-	55	-	
t_r	Rise time		$T_j=25^\circ C$	-	27	-	ns
			$T_j=150^\circ C$	-	18	-	
$t_{d(off)}$	Turn-off delay time		$T_j=25^\circ C$	-	245	-	ns
			$T_j=150^\circ C$	-	290	-	
t_f	Fall time		$T_j=25^\circ C$	-	40	-	ns
			$T_j=150^\circ C$	-	43	-	
E_{on}	Turn-on power dissipation		$T_j=25^\circ C$	-	3.54	-	mJ
			$T_j=150^\circ C$	-	3.35	-	
E_{off}	Turn-off power dissipation		$T_j=25^\circ C$	-	1.59	-	mJ
			$T_j=150^\circ C$	-	1.76	-	
$R_{th(j-e)}$	FET Thermal Resistance	Junction to Case/MOSFET	-	0.12	-	K/W	
$R_{th(c-f)}$	Contact thermal resistance	With thermal conductive grease/MOSFET	-	0.15	-	K/W	

Assumes Thermal Conductivity of grease is 2.8 W/m·K and thickness is 50um.

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Body Diode Electrical characteristics ($T_j=25^\circ\text{C}$ unless otherwise specified, chip: Target)

Symbol	Item	Condition	Value			Unit	
			Min.	Typ.	Max		
V_{SD}	Body Diode Forward Voltage	$V_{GS}=0\text{V}$ $I_{SD}=150\text{A}$	$T_j=25^\circ\text{C}$	-	3.3	-	V
			$T_j=150^\circ\text{C}$	-	4.0	-	
T_{rr}	Reverse recovery time	$V_{DD}=600\text{V}$ $I_D=150\text{A}$	$T_j=25^\circ\text{C}$	-	41.5	-	ns
			$T_j=150^\circ\text{C}$	-	45	-	
Q_{rr}	Reverse recovery charge	$V_{GS}=+18/0\text{V}$ $R_G=3.3\Omega$	$T_j=25^\circ\text{C}$	-	2.19	-	μC
			$T_j=150^\circ\text{C}$	-	3.94	-	
E_{rr}	Diode switching power dissipation	Inductive load switching operation	$T_j=25^\circ\text{C}$	-	0.64	-	mJ
			$T_j=150^\circ\text{C}$	-	1.42	-	

Test Conditions

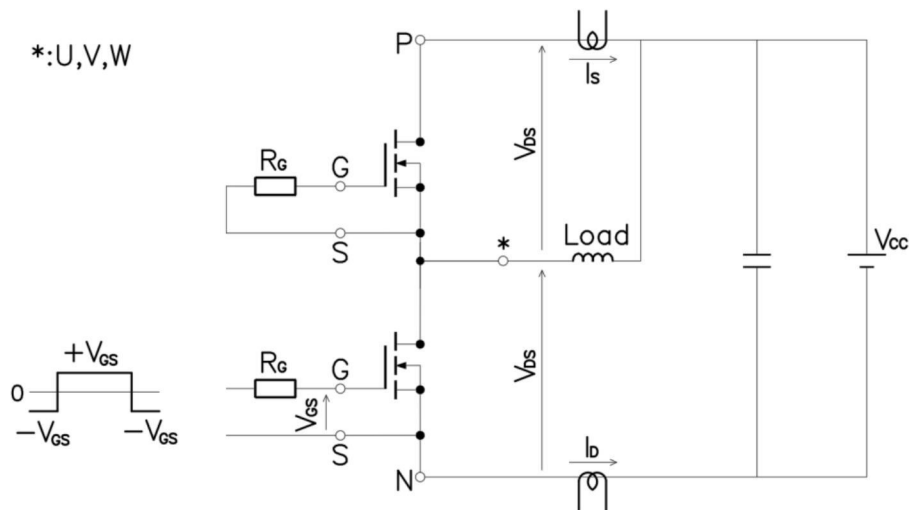


Figure 3. Switching time measure circuit

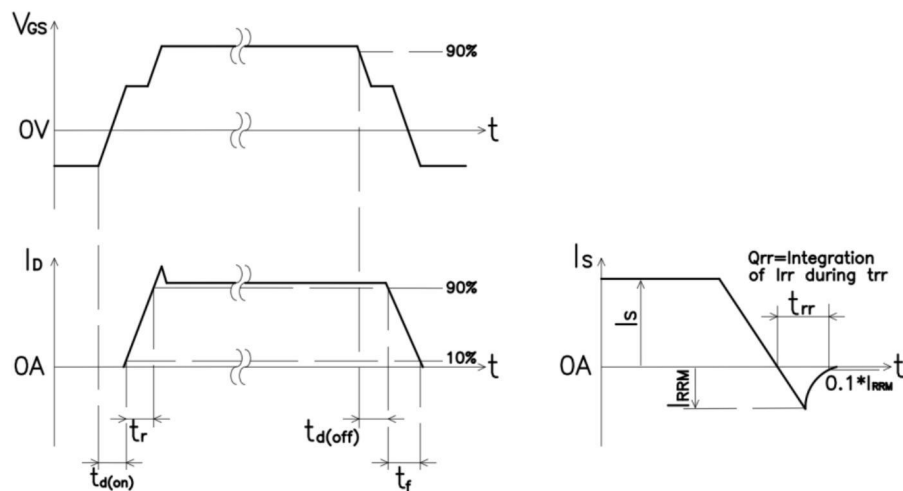


Figure 4. Switching time definition

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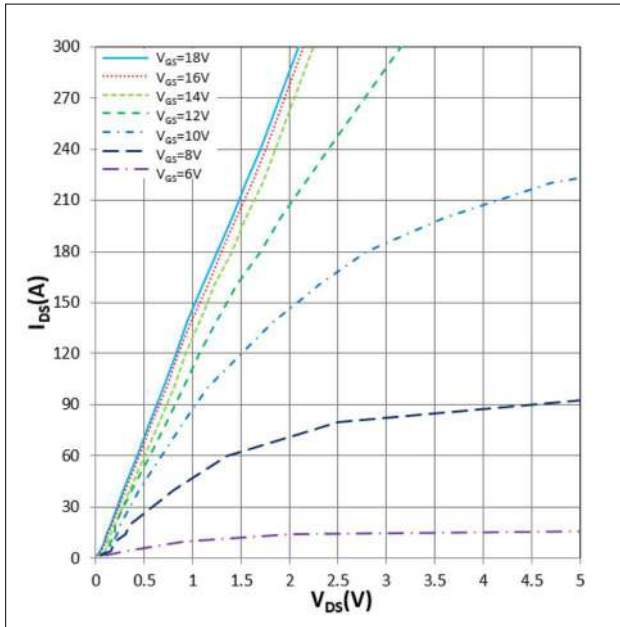


Figure 5. I_{DS} vs V_{DS}
 $T_j = 25^\circ\text{C}$, V_{GS} parameter

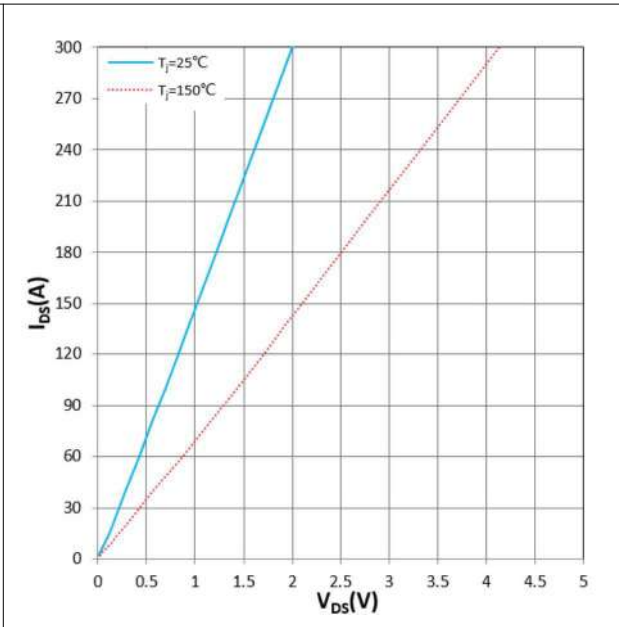


Figure 6. I_{DS} vs V_{DS}
 $V_{GS} = +18\text{V}$

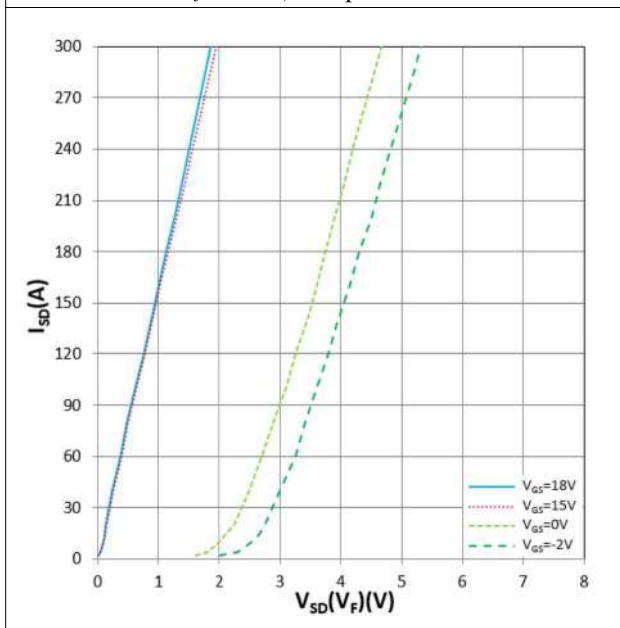


Figure 7. I_{SD} vs $V_{SD} (V_F)$
 $T_j = 25^\circ\text{C}$, V_{GS} parameter

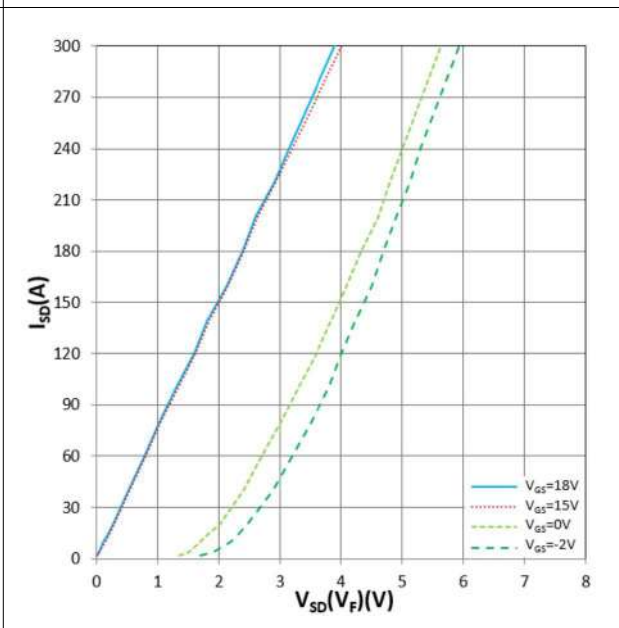


Figure 8. I_{SD} vs $V_{SD} (V_F)$
 $T_j = 150^\circ\text{C}$, V_{GS} parameter

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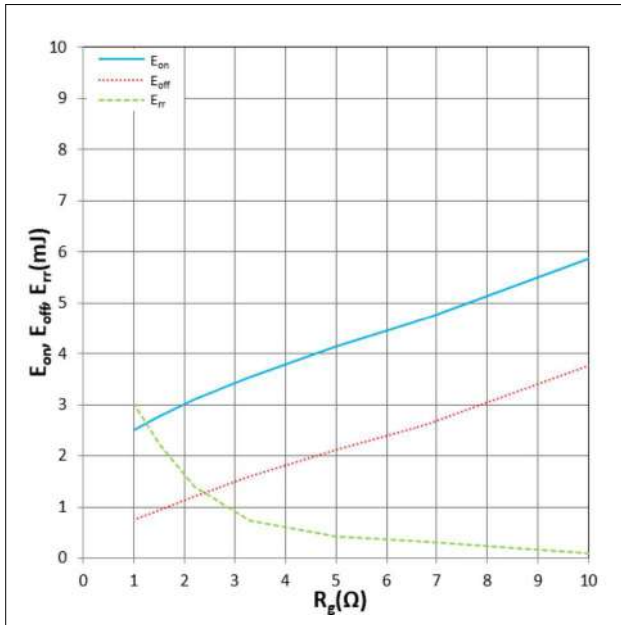


Figure 9. E_{on} , E_{off} , E_{tr} vs R_G
 $T_j = 25^\circ\text{C}$, $I_D = 150\text{A}$, $V_{GS} = +18\text{V}/0\text{V}$

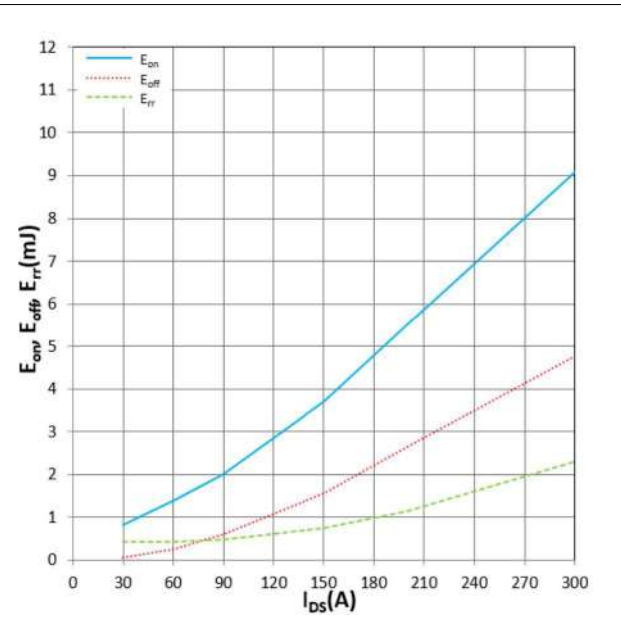


Figure 10. E_{on} , E_{off} , E_{tr} vs I_{DS}
 $T_j = 25^\circ\text{C}$, $R_G = 3.3\Omega$, $V_{GS} = +18\text{V}/0\text{V}$

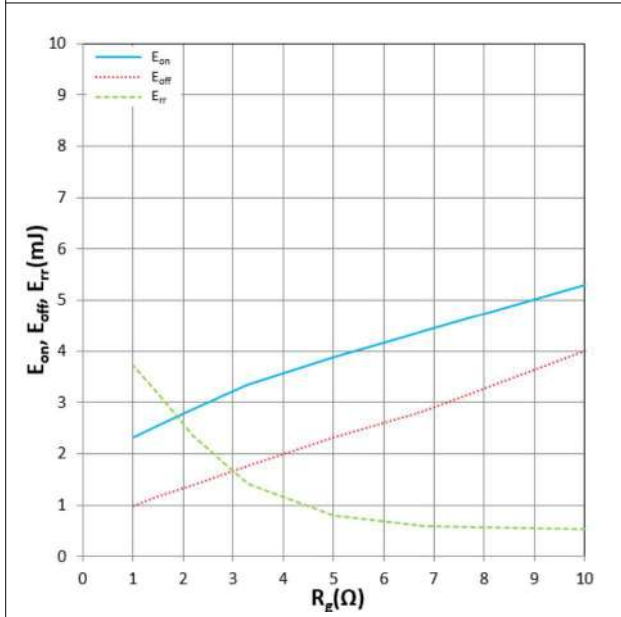


Figure 11. E_{on} , E_{off} , E_{tr} vs R_G
 $T_j = 150^\circ\text{C}$, $I_D = 150\text{A}$, $V_{GS} = +18\text{V}/0\text{V}$

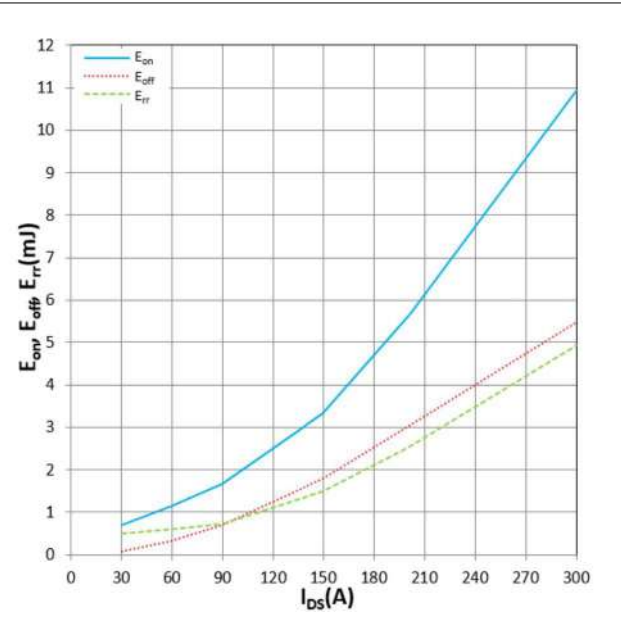
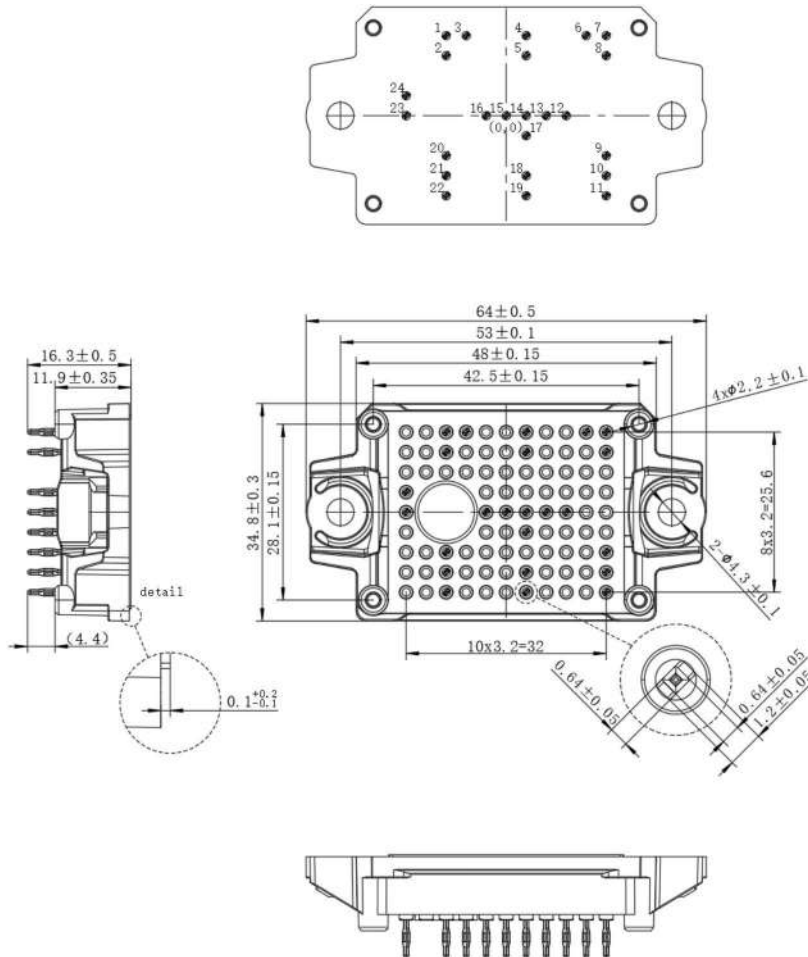


Figure 12. E_{on} , E_{off} , E_{tr} vs I_{DS}
 $T_j = 150^\circ\text{C}$, $R_G = 3.3\Omega$, $V_{GS} = +18\text{V}/0\text{V}$

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Package dimensions



Pin table		
Pin	X	Y
1	-9.6	12.8
2	-9.6	9.6
3	-6.4	12.8
4	3.2	12.8
5	3.2	9.6
6	12.8	12.8
7	16	12.8
8	16	9.6
9	16	-6.4
10	16	-9.6
11	16	-12.8
12	9.6	0
13	6.4	0
14	3.2	0
15	0	0
16	-3.2	0
17	3.2	-3.2
18	3.2	-9.6
19	3.2	-12.8
20	-9.6	-6.4
21	-9.6	-9.6
22	-9.6	-12.8
23	-16	0
24	-16	3.2

IMPORTANT NOTICE

This product data sheet describes the characteristics of this product for which a warranty is granted. Any such warranty is granted exclusively under the terms and conditions of the supply agreement. There will be no guarantee or of any kind for the product and its characteristics.

The data contained in this document is exclusively intended for technically trained staff. You and your technical departments will have to evaluate the product's suitability for the intended application and the completeness of the product data concerning such application.

Due to technical requirements, our product may contain dangerous substances. For information on the types in question, please contact the sales staff responsible for you.

Changes to this product data sheet are reserved.

Please contact the sales staff (sales@hiitio.com) for further information on the product, technology, delivery terms, conditions and prices.

Instruction note

Naming rules for power module product models (Industrial module)

Product Model																																							
	HC	S	05	FF	120	E0	Q1																																
Hecheng Code																																							
Module type G : IGBT module D : FRD module S : SiC module H : Si/SiC hybrid																																							
On-state resistance (mΩ) 01~80																																							
Topology structure FZ : A switch unit FF : Half bridge FS : Three phase F4 : H Bridge F3L : Three level DF : Boost Circuit FD : Braking Circuit FP : Rectification+Inverter+Control move AL : ANPC CL : Chopper																																							
Voltage level (x10) (V) 650~2200																																							
Packaging form+features (A...Z) <table border="0"> <tr> <td>A1: 34 mm</td> <td>A2: 62 mm</td> <td></td> <td></td> </tr> <tr> <td>B1: Easy 1B</td> <td>B1A</td> <td>B1B...</td> <td></td> </tr> <tr> <td>B2: Easy 2B...</td> <td>B3: Easy 3B...</td> <td></td> <td></td> </tr> <tr> <td>D1: Flow0</td> <td>D2: Flow1</td> <td>D3: Flow2</td> <td></td> </tr> <tr> <td>E0: E0</td> <td>E1: Econo 2...</td> <td>E2: E2</td> <td></td> </tr> <tr> <td>E3: ED3</td> <td>E4: E4</td> <td>E5: ED3S</td> <td></td> </tr> <tr> <td>E6: EPM2</td> <td>E7: EPM3</td> <td>E8: EconoPIM3</td> <td></td> </tr> <tr> <td>E9: ED3H</td> <td>F0: F0</td> <td>P2: EPM2</td> <td></td> </tr> </table>								A1: 34 mm	A2: 62 mm			B1: Easy 1B	B1A	B1B...		B2: Easy 2B...	B3: Easy 3B...			D1: Flow0	D2: Flow1	D3: Flow2		E0: E0	E1: Econo 2...	E2: E2		E3: ED3	E4: E4	E5: ED3S		E6: EPM2	E7: EPM3	E8: EconoPIM3		E9: ED3H	F0: F0	P2: EPM2	
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E6: EPM2	E7: EPM3	E8: EconoPIM3																																					
E9: ED3H	F0: F0	P2: EPM2																																					
Feature :A: Special Code Nil: Standard																																							

Zhejiang HIITIO New Energy Co., Ltd

ADD : NO.1125 Zhixing Road,Qiaonan District, Xiaoshan Economic and Technological Development Zone, Hangzhou, Zhejiang

TEL :400-667-9977

